

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Shinichi FUJIWARA	09/13/2007
Masahide HARADA	09/21/2007
Hideto YOSHINARI	09/06/2007
Shosaku ISHIHARA	09/19/2007
Shiro YAMASHITA	09/13/2007
Isamu YOSHIDA	09/13/2007
Ukyo IKEDA	09/14/2007
RECEIVING PARTY DATA	
Name:	Hitachi, Ltd.
Street Address:	6-6, Marunouchi 1-chome
Internal Address:	Chiyoda-ku
City:	Tokyo
State/Country:	JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11834724
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OP \$40.00 11834724

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REEL: 019975 FRAME: 0197

NAME OF SUBMITTER:

Gregory E. Montone

Total Attachments: 1

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ASSIGNMENT

(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi, Ltd., a corporation organized under the laws of Japan, located at 6-6, Marunouchi 1-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi, Ltd., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

POWER SEMICONDUCTOR MODULE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi, Ltd., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi, Ltd.

Signed on the date(s) indicated aside signatures:

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1)	<u>Shinichi Fujiwara</u> Shinichi FUJIWARA	<u>9/13/07</u>
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3)	<u>Hideto Yoshinari</u> Hideto YOSHINARI	<u>9/6/07</u>
4)	<u>Shosaku Ishihara</u> Shosaku ISHIHARA	<u>9/19/07</u>
5)	<u>Shiro Yamashita</u> Shiro YAMASHITA	<u>9/13/07</u>
6)	<u>Isamu Yoshida</u> Isamu YOSHIDA	<u>9/13/07</u>
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10)	<u></u>	<u></u>

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